

BM152M

Version: A1 2023-07-18

Order Code: BM152M

Gas Discharge Tube

Features

• Size Design 8.3×8.3×6mm

High Current Handling Capability 10,000A @ 8/20μs

Low Capacitance and Insertion Loss

Fast Response and Long Service Life

Reliable to Protect Electrostatic Surge

Moisture Sensitivity Level: Level 1

Application information

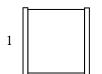
AC Power Port

Exterior



**SMD** 

Package (Top View)

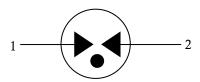


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Agency Approvals

Icon	Description
RoHS	Compliance with 2011/65/EU
HF	Compliance with IEC61249-2-21:2003
<b>®</b>	Mean lead free
<i>IR</i> .	Compliance with UL1449, Certificated E337906

Schematic Symbol



#### **Electrical Parameter**

DC Breakdown Voltage <sup>1 / 2 /</sup>	100V/s	1200-1800	V
Impulse Spark-over Voltage	At 1kV/μs	≤ 2000	V
Impulse Discharge Current <sup>3)</sup>	8/20μs ±5times	10	kA
Arc Voltage	At 1A	~15	V
Insulation Resistance	DC=100V	≥1	GΩ
Co (1MHz)	V <sub>DC</sub> =0.5V	≤1.5	pF
Weight		~1.65	g
Operating and storage Temperature		-40-125	$^{\circ}\!\mathbb{C}$
Marking		without	

- 1) At delivery AQL 0.65 level II ISO 2859
- 2) In ionized mode
- 3) Terms and current waveforms in accordance with ITU-T Rec. K. 12; IEC 61643-21



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### Part Numbering System

BM 152 M (1) (2) (3)

- (1)Bencent SMD Gas Discharge Tube in  $8.3\times8.3\times6$  (L×W×H) (mm)
- (2) DC Breakdown Voltage, e.g., 152=15×10<sup>2</sup>=1500V
- (3) Tolerance is DC Breakdown Voltage, M=±20%, N=±30%

#### **Product Characteristics**

Lead Material	Copper
Body Material	Ceramics
Terminal Finish	100% Matte-Tin Plated

### **Environmental Reliability Characteristics**

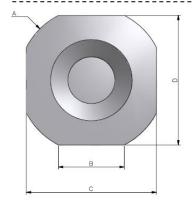
Testing items	Technical standards
High Temperature Storage Test	Temperature: 125°C Time:2H
Low Temperature Storage Test	Temperature: -40°C Time:2H
Vibration	Frequency: 10-500Hz Amplitude: 0.15mm Time: 45min
Resistance of soldering heat	Temperature: 260±5°C Time of dip soldering: 10s, 3time

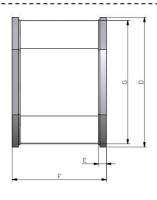
Note: Up-screen program can be specified by customer's request via contacting Bencent service

## Solderability test

Solderability	Solder Pot Temperature:	245℃±5℃	Lead-Free Recommendation
Solderability	Solder Dwell Time:	4-6 seconds	

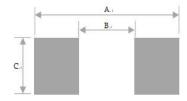
### **Product Dimensions**





REF	mm inch		
A	Φ9.3±0.1	Φ0.366±0.004	
В	4.2±0.1	0.165±0.004	
С	8.3±0.2	0.327±0.008	
D	8.3±0.2	0.327±0.008	
Е	0.5±0.05	0.02±0.002	
F	6±0.2	0.236±0.008	
G	7.9±0.2	0.311±0.008	

### Recommended soldering pad



REF	mm	inch
A	7.95	0.313
В	4.5	0.177
С	8	0.315



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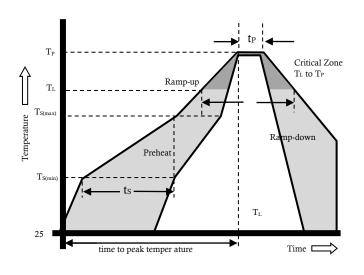


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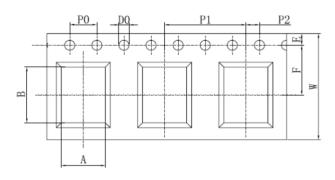
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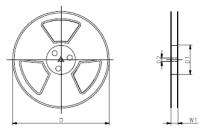
## Reflow profile

Reflow Condition		low Condition	Pb-Free assembly	
D	Te	emperature Min	150°C	
Pre Heat	Te	emperature Max	200°C	
пеа	T	ime (min to max)	60 – 180 secs	
Average ramp up rate (Liquids) $Tamp (T_L) to peal$			3°C/second max	
T <sub>S</sub> (max) to T <sub>L</sub> - Ramp-up Rate		T <sub>L</sub> - Ramp-up Rate	3°C/second max	
Reflow		- Temperature (T <sub>L</sub> ) (Liquids)	217°C	
	- Temperature (T <sub>L</sub> )		60 – 150 seconds	
Peak Te	mp	erature (T <sub>p</sub> )	260+0/-5 °C	
Time within 5°C of actual peak Temperature (t <sub>p</sub> )		-	20 – 40 seconds	
Ramp-down Rate		n Rate	6°C/second max	
Time 25°C to peak Temperature $(T_p)$		to peak Temperature	8 minutes Max.	
Do not	exc	eed	260°C	



# Package Reel Information





REF	mm	inch
P0	4.0±0.1	0.157±0.004
D0	$\Phi 1.5^{+0.1}_{-0}$	$\Phi 0.059^{+0.004}_{-0}$
P1	12±0.1	0.472±0.004
P2	2.0±0.1	$0.079 \pm 0.004$
A	$6.5 \pm 0.2$	$0.256 \pm 0.008$
В	$8.4 \pm 0.2$	$0.331 \pm 0.008$
F	7.5±0.1	0.295±0.004
E	1.75±0.1	0.069±0.004
W	16±0.3	0.63±0.012
D	Ф330±2	Φ12.99±0.079
D1	$\Phi 100^{+1}_{-2}$	$\Phi 3.94^{+0.039}_{-0.078}$
D2	Φ13±0.15	0.512±0.006
W1	16.5±0.4	0.65±0.016

	222	INSIDE	DED 01.DE01.	CARTON SIZE(mm)		
OUTLINE	REEL (PCS)	CARTON (PCS)	PER CARTON (PCS)	L	W	Н
TAPING	500	1000	8000	360	360	380